

# WNM3400

**Single N-Channel, 30V, 5.2A, Power MOSFET**

[Http://www.sh-willsemi.com](http://www.sh-willsemi.com)

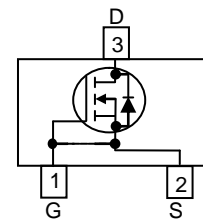
V <sub>DS</sub> (V)	Typical R <sub>DS(on)</sub> (mΩ)
30	24 @ V <sub>GS</sub> = 10.0V
	25 @ V <sub>GS</sub> = 4.5V
	27 @ V <sub>GS</sub> = 3.1V
	29 @ V <sub>GS</sub> = 2.5V



**SOT-23**

## Descriptions

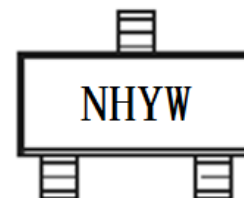
The WNM3400 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WNM3400 is Pb-free



**Pin configuration (Top view)**

## Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-23



NH = Device Code  
 Y = Year  
 W = Week(A~z)

## Applications

- DC/DC converters
- Power supply converters circuit
- Load/Power Switching for portable device

### Marking

### Order information

Device	Package	Shipping
WNM3400-3/TR	SOT-23	3000/Tape&Reel

**Absolute Maximum ratings**

Parameter	Symbol	Maximum	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	
Continuous Drain Current	$I_D$	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
Pulsed Drain Current <sup>c</sup>	$I_{DM}$	30	
Maximum Power Dissipation <sup>b</sup>	$P_D$	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
Operating Junction Temperature	$T_J$	-55 to 150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to 150	$^\circ\text{C}$

**Thermal resistance ratings**

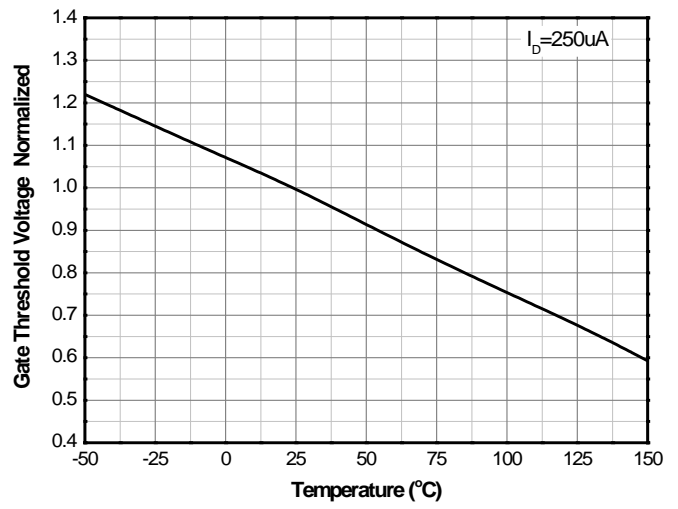
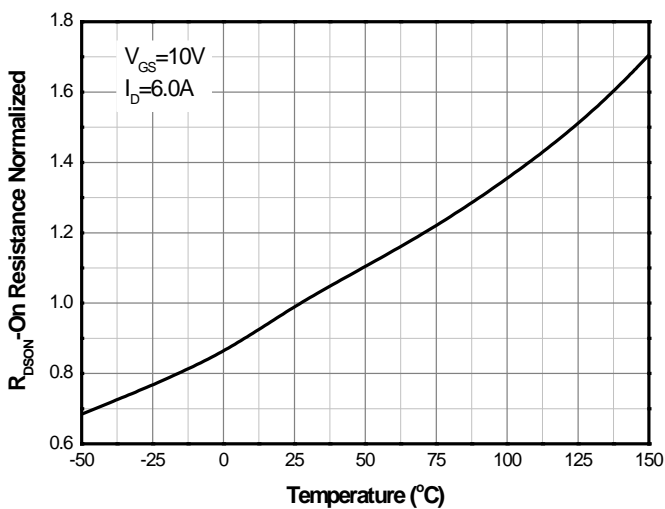
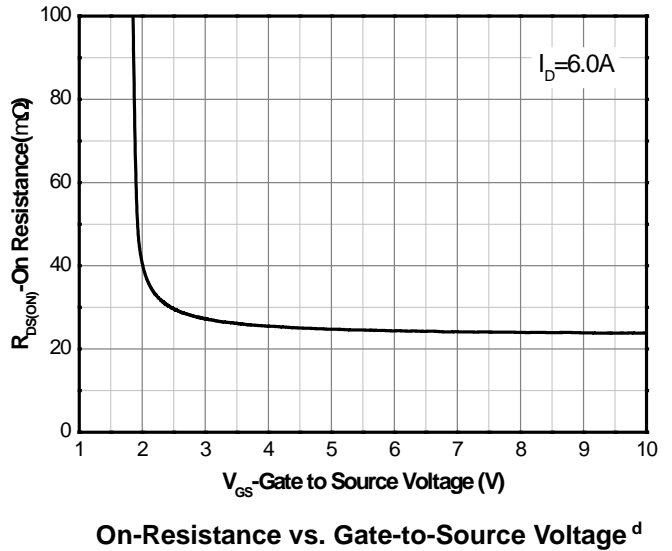
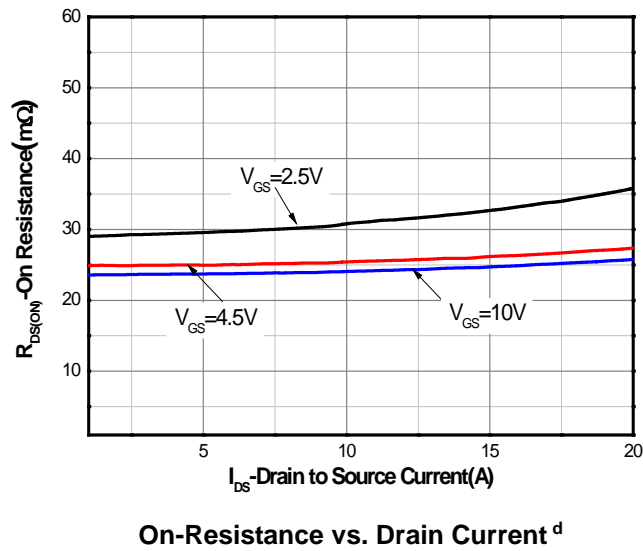
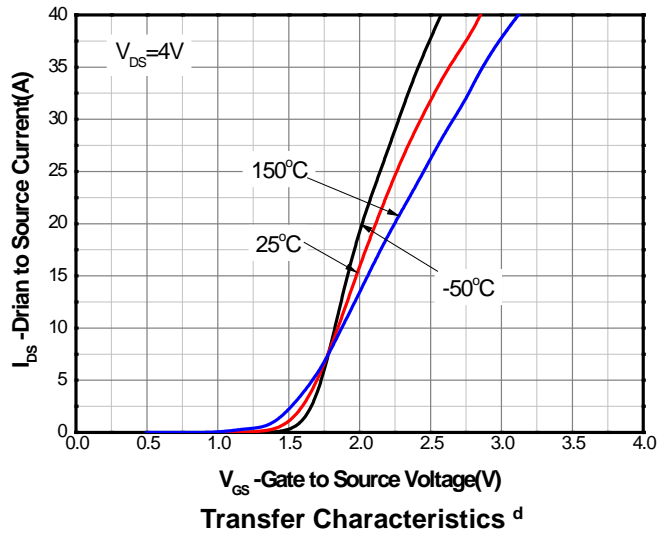
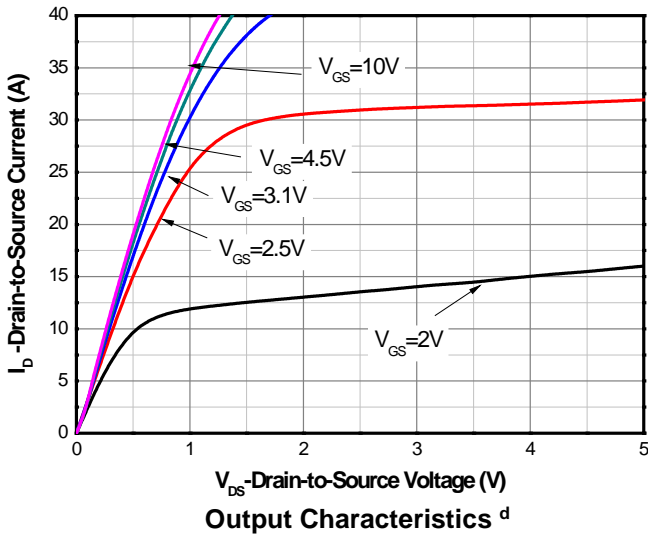
Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance <sup>a</sup>	$R_{\theta JA}$	$t \leq 10 \text{ s}$	60	$^\circ\text{C/W}$
		Steady State	88	
Junction-to-Lead Thermal Resistance	$R_{\theta JL}$	39	49	

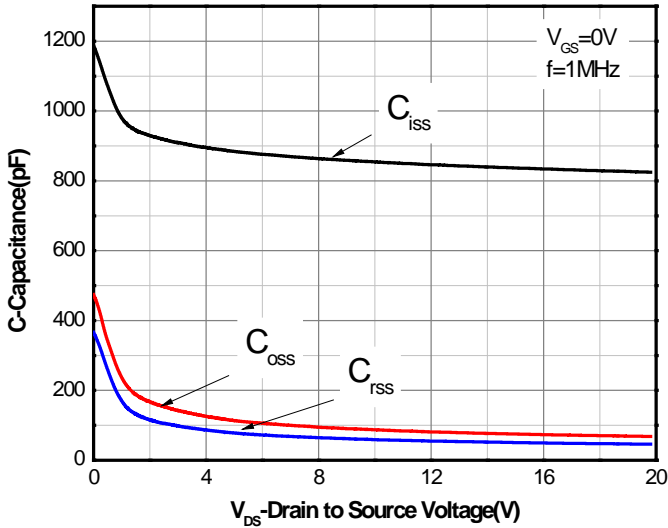
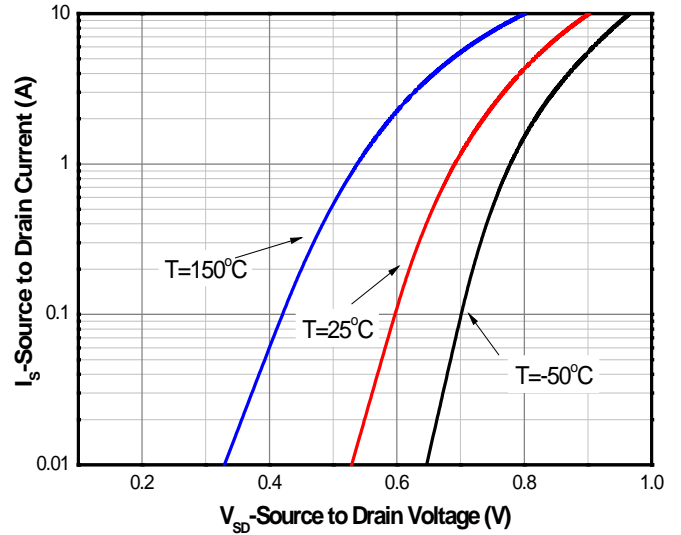
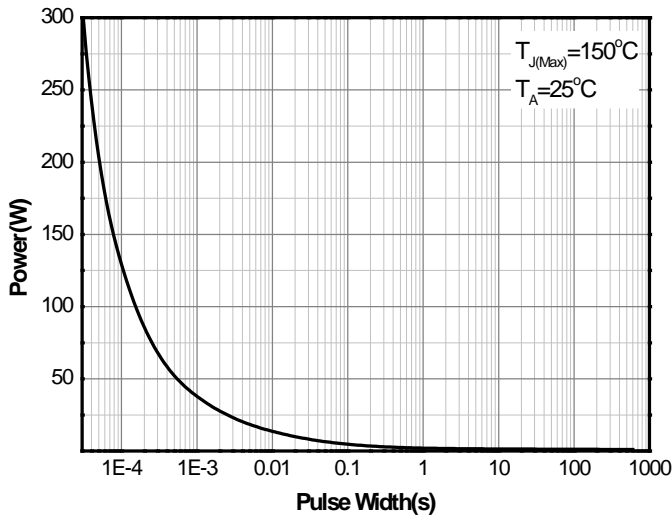
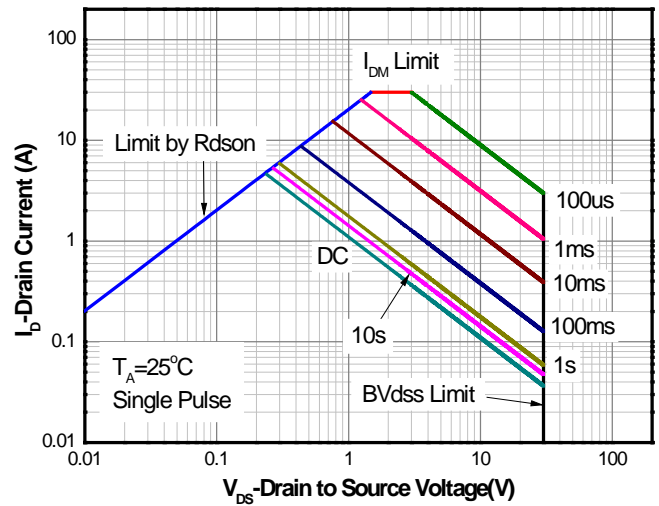
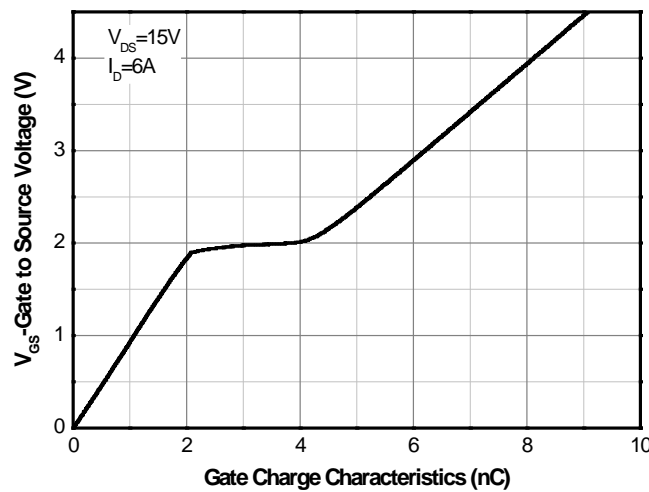
**Note:**

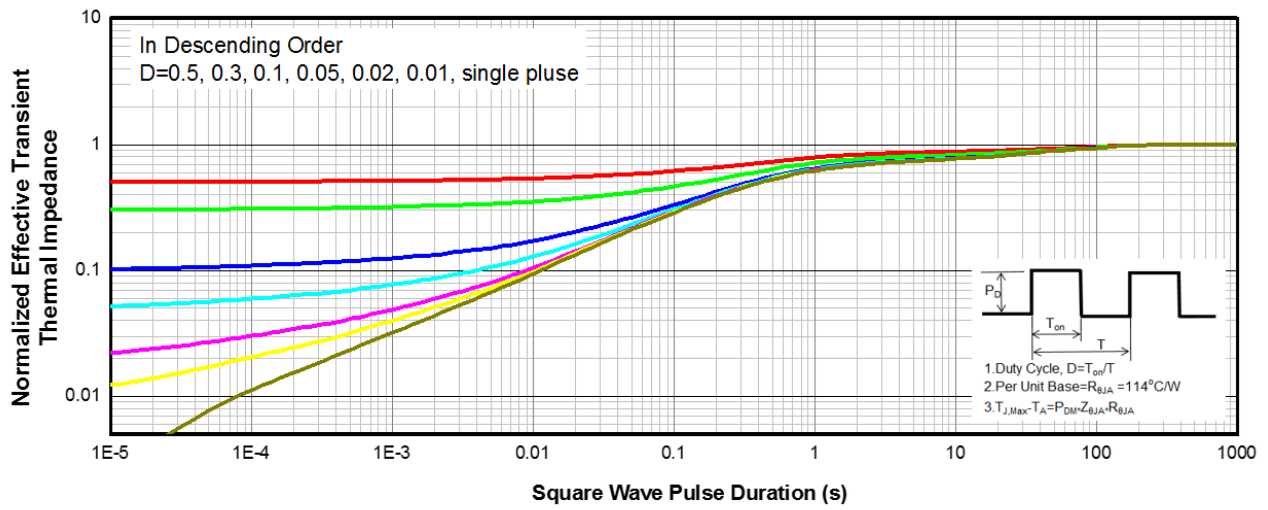
- The value of  $R_{\theta JA}$  is measured with the device mounted on 1-inch<sup>2</sup> (6.45cm<sup>2</sup>) with 2oz.(0.071mm thick) Copper pad on a 1.5\*1.5 inch<sup>2</sup>, 0.06-inch thick FR4 PCB, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application is determined by the user's specific board design
- The power dissipation  $P_D$  is based on Junction-to-Ambient thermal resistance  $R_{\theta JA}$   $t \leq 10\text{s}$  value and the  $T_{J(\text{MAX})}=150^\circ\text{C}$ .
- Repetitive rating, ~10us pulse width, duty cycle ~1%, keep initial  $T_J = 25^\circ\text{C}$ , the maximum allowed junction temperature of 150 $^\circ\text{C}$ .
- The static characteristics are obtained using ~380us pulses, duty cycle ~1%.

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

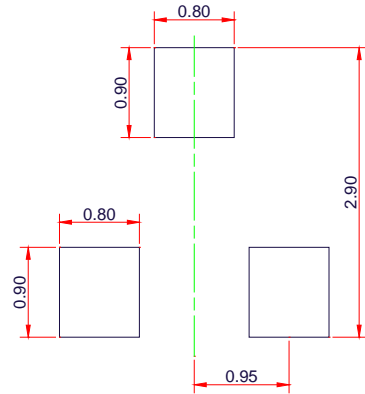
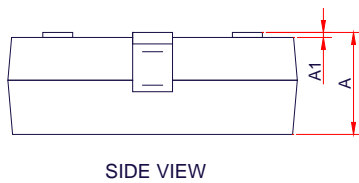
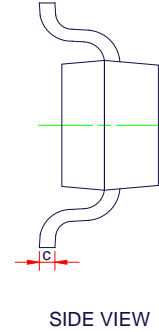
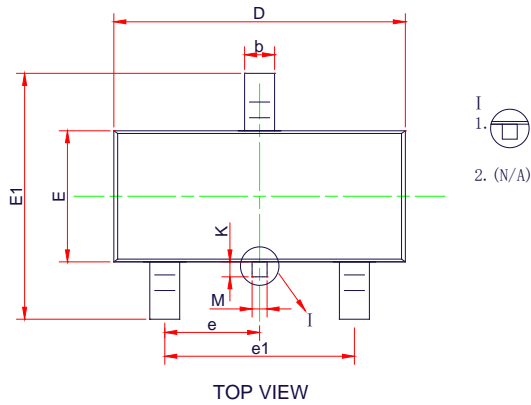
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 10\text{ V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	0.7	1.0	1.5	V
Drain-to-source On-resistance <sup>d</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 6.0\text{ A}$		24	30	m $\Omega$
		$V_{GS} = 4.5\text{ V}, I_D = 5.0\text{ A}$		25	31	
		$V_{GS} = 3.1\text{ V}, I_D = 3.5\text{ A}$		27	36	
		$V_{GS} = 2.5\text{ V}, I_D = 2.0\text{ A}$		29	44	
<b>CHARGES, CAPACITANCES AND GATE RESISTANCE</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{ V}, f = 1.0\text{ MHz},$ $V_{DS} = 15\text{ V}$		837		pF
Output Capacitance	$C_{OSS}$			75		
Reverse Transfer Capacitance	$C_{RSS}$			51		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = 4.5\text{ V}, V_{DS} = 15\text{ V},$ $I_D = 6.0\text{ A}$		9.1		nC
Threshold Gate Charge	$Q_{G(TH)}$			1.1		
Gate-to-Source Charge	$Q_{GS}$			1.8		
Gate-to-Drain Charge	$Q_{GD}$			2.2		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_d(ON)$	$V_{GS} = 10\text{ V}, V_{DS} = 15\text{ V},$ $R_L = 2.5\Omega, R_G = 3\Omega$		9.2		ns
Rise Time	$t_r$			4.2		
Turn-Off Delay Time	$t_d(OFF)$			48.8		
Fall Time	$t_f$			6.4		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{ V}, I_S = 1.0\text{ A}$		0.7	1.2	V

**Typical Characteristics (Ta=25°C, unless otherwise noted)**


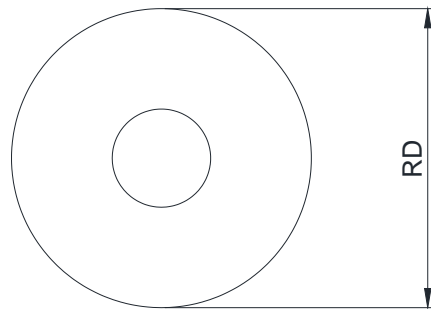
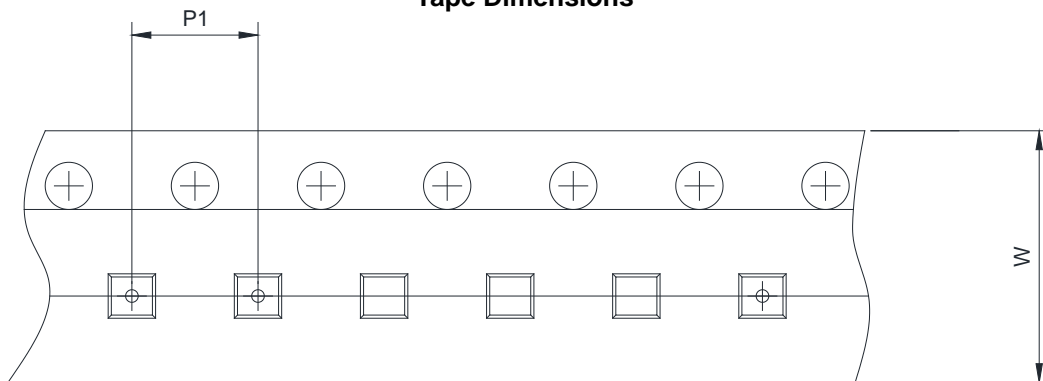
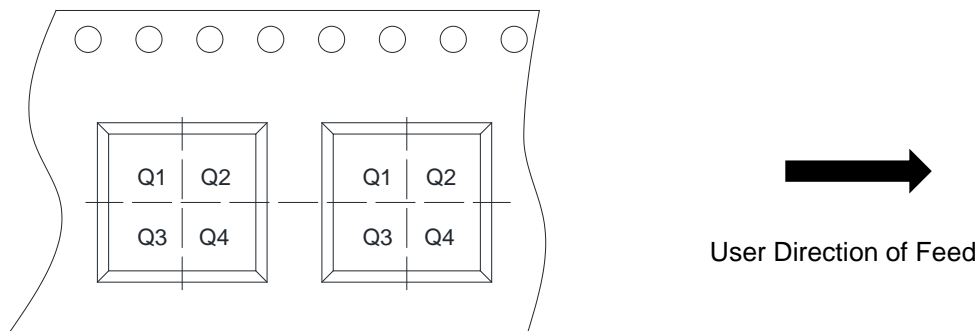

**Capacitance**

**Body Diode Forward Voltage<sup>d</sup>**

**Single Pulse power**

**\* $V_{GS}$ >minimum  $V_{GS}$  at which  $R_{DS(ON)}$  is specified  
Safe Operating Power**

**Gate Charge Characteristics**



**Transient thermal response (Junction-to-Ambient)**

**Package outline dimensions**
**SOT-23**


Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.89	1.10	1.30
A1	0.00	-	0.10
b	0.30	0.43	0.55
c	0.05	-	0.21
D	2.70	2.90	3.10
E	1.15	1.33	1.50
E1	2.10	2.40	2.70
e	0.95 Typ.		
e1	1.70	1.90	2.10
M	0.10	0.15	0.25
K	0.00	-	0.25

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


RD	Reel Dimension	<input checked="" type="checkbox"/> 7inch	<input type="checkbox"/> 13inch
W	Overall width of the carrier tape	<input checked="" type="checkbox"/> 8mm	<input type="checkbox"/> 12mm <input type="checkbox"/> 16mm
P1	Pitch between successive cavity centers	<input type="checkbox"/> 2mm	<input checked="" type="checkbox"/> 4mm <input type="checkbox"/> 8mm
Pin1	Pin1 Quadrant	<input type="checkbox"/> Q1	<input type="checkbox"/> Q2 <input checked="" type="checkbox"/> Q3 <input type="checkbox"/> Q4



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